

ATTY. DOCKET NO.

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APPLICATION NO.

09/365,356

INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

APPLICANT(S)

Tongbi Jiang

FILING DATE

July 30, 1999

GROUP ART UNIT

2813

U.S. PATENT DOCUMENTS

EXAMINER CLASS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
NB	AA 5,122,858	06/16/92	Mahulikar et al.	357	70	1
NB	AB 5,304,842	04/19/94	Farnworth et al.	257	668	1
NB	AC 5,840,598	11/24/98	Grigg et al.	438	118	1
NB	AD 5,943,557	08/24/99	Moden	438	118	1
NB	AE 6,107,679	08/22/00	Noguchi	257	678	1
	AF					
	AG					
	AH					
	AI					
	AJ					

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
NB	AK	1-244652	09/29/89	Japan (Abstract only)		1	X	
NB	AL	2-105443	04/18/90	Japan (Abstract only)		1	X	
NB	AM	4-199723	07/20/92	Japan		1		X
	AN							
	AO							

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

NB	AP	Electronic Packaging and Interconnection Handbook, New York, McGraw-Hill, Inc., pp. 2.2-2.7.
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EXAMINER

Nema Berezny

DATE CONSIDERED

12-18-01

* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).